

TE Internal #: 6364666-5

Board-to-Board Card Edge Power Connector, 62 Position, 2.54 mm

[.1 in] Centerline, Power & Signal, 62 Power Positions, 0 Signal

Positions

View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: Board-to-Board

Number of Positions: 62

Centerline (Pitch): 2.54 mm [.1 in]

Contact Current Rating (Max): 4.26 A

Circuit Application: Power & Signal

Features

| Industry Standards | |
|----------------------------|-----------------------|
| UL Flammability Rating | UL 94V-0 |
| Body Features | |
| Primary Product Color | Black |
| Mechanical Attachment | |
| Connector Mounting Type | Board Mount |
| Mating Retention Type | Latch |
| PCB Mount Retention | With |
| Mating Retention | With |
| PCB Mount Retention Type | Action/Compliant Tail |
| Mating Alignment Type | Keyed |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| Packaging Features | |
| Packaging Quantity | 5 |
| Packaging Method | Box |
| Other | |
| Position Locations Omitted | 6 |
| | |

Compliant

EU RoHS Compliance



| EU ELV Compliance | Compliant |
|---|-----------------------|
| Termination Features | |
| Termination Post & Tail Length | 3.18 mm[.125 in] |
| Termination Method to PCB | Through Hole - Solder |
| Dimensions | |
| Card Slot Depth | 7.64 mm[.31 in] |
| Row-to-Row Spacing | 4.85 mm[.191 in] |
| Connector Height | 15.64 mm[.76 in] |
| Power Contact Centerline | 2.54 mm[.1 in] |
| Contact Features | |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin] |
| PCB Contact Termination Area Plating Material Thickness | 2.54 μm[100 μin] |
| Contact Base Material | Phosphor Bronze |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Type | Socket |
| Contact Current Rating (Max) | 4.26 A |
| Contact Mating Area Plating Material | Gold |
| Housing Features | |
| Housing Material | Polyester GF |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Configuration Features | |
| Keying & Polarized Position Locations | 1213 |
| PCB Mount Orientation | Vertical |
| Number of Positions | 62 |
| Number of Power Positions | 62 |
| Number of Signal Positions | 0 |
| Number of Dual Positions | 31 |
| Product Type Features | |
| Connector & Contact Terminates To | Printed Circuit Board |
| Connector Mates With | Printed Circuit Board |
| | |



| Connector & Housing Type | Receptacle |
|-----------------------------|---------------------------|
| Connector System | Board-to-Board |
| Electrical Characteristics | |
| Operating Voltage | 400 V |
| Usage Conditions | |
| Operating Temperature Range | -55 – 90 °C[-67 – 194 °F] |
| Operation/Application | |
| Circuit Application | Power & Signal |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts





Customers Also Bought



TE Part #1-641970-1 06P UMNL PIN HDR ASSY 94VO BLK



















Documents

Product Drawings
CONN SEC II 31 POS W/ LATCH

English

CAD Files

Customer View Model ENG_CVM_6364666-5_D.3d_igs.zip

English

Customer View Model

Board-to-Board Card Edge Power Connector, 62 Position, 2.54 mm [.1 in] Centerline, Power & Signal, 62 Power Positions, 0 Signal Positions



ENG_CVM_6364666-5_D.3d_stp.zip

English

Customer View Model

ENG_CVM_6364666-5_D.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English